



Product Summary

V _{RRM} (V)	I _O (A)	V _F Max (V) @ +25°C	I _R Max (mA) @ +25°C
40	2	0.5	0.1

Description

Packaged in the compact V-DFN5060-4, the SBR2A40BLP is designed with low forward voltage and low reverse leakage to meet the needs of LED lighting applications and wireless charging applications.

Features and Benefits

- Low-Profile Package, Ideal for Thin Portable Applications
- Low Reverse Leakage Ensures Greater Stability at Higher **Temperatures**
- Low Forward Voltage (VF) Minimizes Conduction Losses and Improves Efficiency
- Patented Super Barrier Rectifier SBR® Technology
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

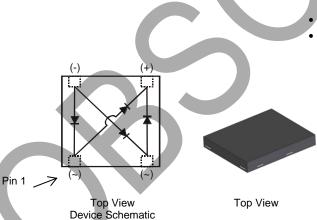
https://www.diodes.com/products/automotive/automotiveproducts/.

This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: V-DFN5060-4
- Package Material: Molded Plastic "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
 - Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.0715 grams (Approximate)





Bottom View

Ordering Information (Note 4)

Part Number	Packago	Packing		
Fait Nulliber	Package	Qty.	Carrier	
SBR2A40BLP-13	V-DFN5060-4	3000	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



SQ4= Product Type Marking Code YM = Date Code Marking Y = Year (ex: K =2023) M = Month (ex: 9 = September)

Year	2011	-	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	Υ	ı	K	L	М	N	Р	R	S	Т	U	V
						_						
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	٧
Average Rectified Output Current	lo	2.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (Per Diode)	IFSM	70	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 5)	Reuc	15	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

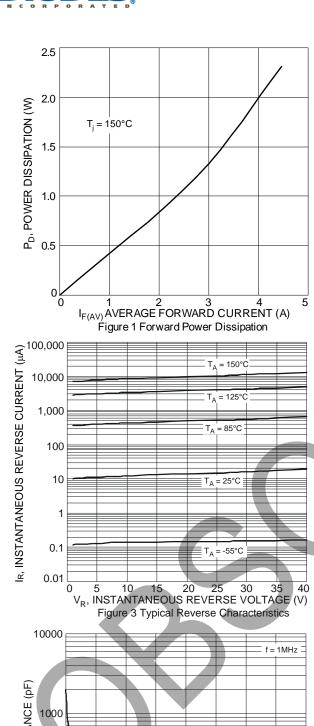
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

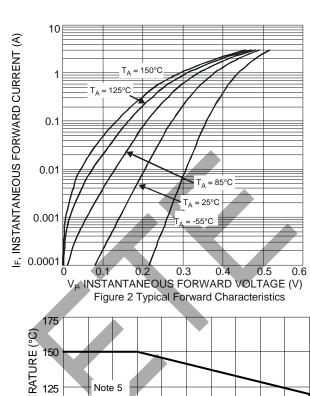
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage (Per Diode)	VF	1	— 0.42	0.50 0.47	\ \ \	I _F = 2.0A, T _J = +25°C I _F = 2.0A, T _J = +125°C
Reverse Current (Note 6) (Per Diode)	lR			0.1 10	l mA	V _R = 40V, T _J = +25°C V _R = 40V, T _J = +125°C
Total Capacitance (Per Diode)	Ст		90		pF	V _R = 40V, f = 1.0MHz, T _J = +25°C

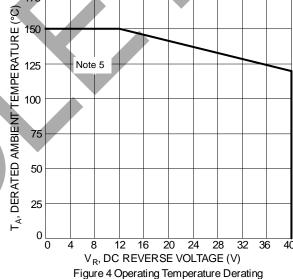
Notes: 5. Device mounted on FR-4 substrate PCB, with minimum recommended pad layout per https://www.diodes.com/package-outlines.html.

6. Short duration pulse test used to minimize self-heating effect.









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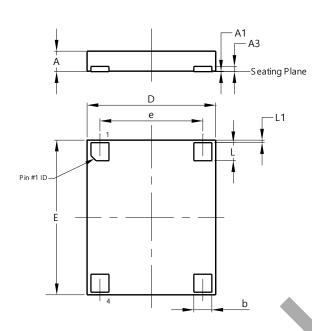
Figure 5 Total Capacitance vs. Reverse Voltage



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN5060-4

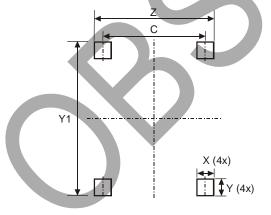


V-DFN5060-4						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0	0.05	0.02			
A3	-	1	0.203			
b	0.65	0.75	0.70			
D	4.95	5.05	5.00			
е	1	ŀ	4.00			
Е	5.95	6.05	6.00			
L	0.65	0.75	0.70			
L	0.05	0.15	0.10			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN5060-4



Dimensions	Value (in mm)		
С	4.00		
Х	0.75		
Υ	0.95		
Y1	6.20		
7	1 75		



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